

Glass Passivated Ultrafast Plastic Rectifier



FEATURES

- Superectifier structure for high reliability condition
- Cavity-free glass passivated pellet chip junction
- Ultrafast reverse recovery time
- Low forward voltage drop
- Low switching losses, high efficiency
- High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

| PRIMARY CHARACTERISTICS | |
|-------------------------|------------------|
| $I_{F(AV)}$ | 1.0 A |
| V_{RRM} | 800 V, 1000 V |
| I_{FSM} | 30 A |
| t_{rr} | 75 ns |
| V_F at I_F | 1.3 V |
| T_J max. | 175 °C |
| Package | DO-204AC (DO-15) |
| Diode variation | Single die |

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

MECHANICAL DATA

Case: DO-204AC, molded epoxy over glass body
Molding compound meets UL 94 V-0 flammability rating
Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

| MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted) | | | | |
|---|-----------------|-------------|----------|------|
| PARAMETER | SYMBOL | BYV26DGP | BYV26EGP | UNIT |
| Maximum repetitive peak reverse voltage | V_{RRM} | 800 | 1000 | V |
| Maximum RMS voltage | V_{RMS} | 560 | 700 | V |
| Maximum DC blocking voltage | V_{DC} | 800 | 1000 | V |
| Maximum average forward rectified current 0.375" (9.5 mm) lead length (fig. 1) | $I_{F(AV)}$ | 1.0 | | A |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I_{FSM} | 30 | | A |
| Non repetitive peak reverse energy | $E_{RSM}^{(1)}$ | 10 | | mJ |
| Operating junction and storage temperature range | T_J, T_{STG} | -65 to +175 | | °C |

Note

⁽¹⁾ Peak reverse energy measured at $I_R = 400\text{ mA}$, $T_J = T_J\text{ max.}$ on inductive load, $t = 20\text{ }\mu\text{s}$



| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | |
|--|---|----------|----------|----------|---------------|
| PARAMETER | TEST CONDITIONS | SYMBOL | BYV26DGP | BYV26EGP | UNIT |
| Minimum avalanche breakdown voltage | 100 μA | V_{BR} | 900 | 1100 | V |
| Maximum instantaneous forward voltage | 1.0 A | V_F | 2.5 | | V |
| | | | 1.3 | | |
| Maximum DC reverse current at rated DC blocking voltage | | I_R | 5.0 | | μA |
| | | | 150 | | |
| Max. reverse recovery time | $I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{rr} = 0.25\text{ A}$ | t_{rr} | 75 | | ns |
| Typical junction capacitance | 4.0 V, 1 MHz | C_J | 15 | | pF |

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | |
|---|-----------------------|----------|----------|--------------------|
| PARAMETER | SYMBOL | BYV26DGP | BYV26EGP | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)}$ | 70 | | $^\circ\text{C/W}$ |
| | $R_{\theta JL}^{(2)}$ | 16 | | |

Notes

- (1) Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length, mounted on PCB with 0.5" x 0.5" (12 mm x 12 mm) copper pads
- (2) Thermal resistance from junction to lead at 0.375" (9.5 mm) lead length with both leads attached to heatsink

| ORDERING INFORMATION (Example) | | | | |
|---------------------------------------|-----------------|------------------------|---------------|----------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| BYV26EGP-E3/54 | 0.428 | 54 | 4000 | 13" diameter paper tape and reel |
| BYV26EGP-E3/73 | 0.428 | 73 | 2000 | Ammo pack packaging |

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

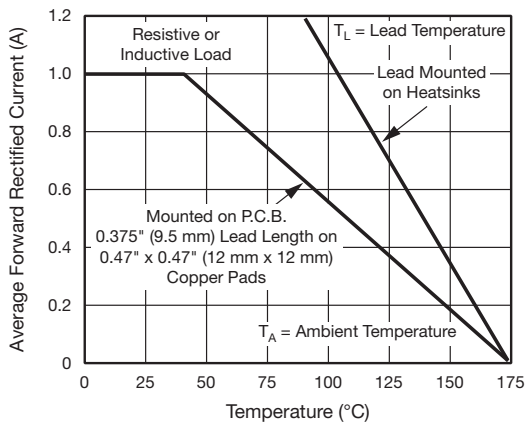


Fig. 1 - Maximum Forward Current Derating Curve

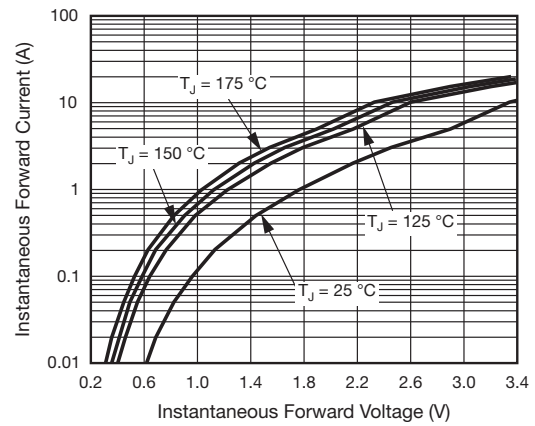


Fig. 4 - Typical Instantaneous Forward Voltage Characteristics

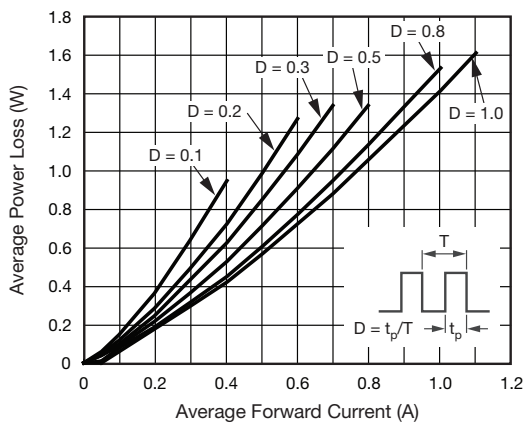


Fig. 2 - Forward Power Loss Characteristics

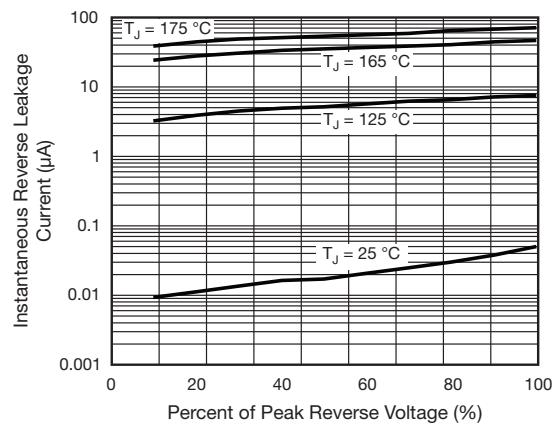


Fig. 5 - Typical Reverse Leakage Characteristics

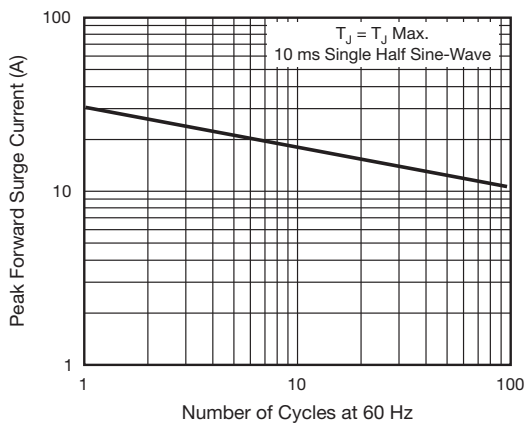


Fig. 3 - Maximum Non-Repetitive Peak Forward Surge Current

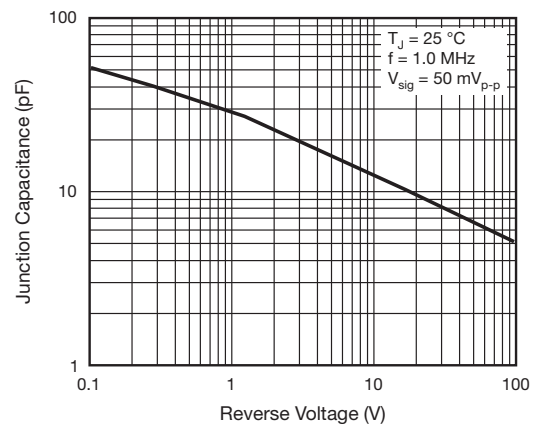


Fig. 6 - Typical Junction Capacitance

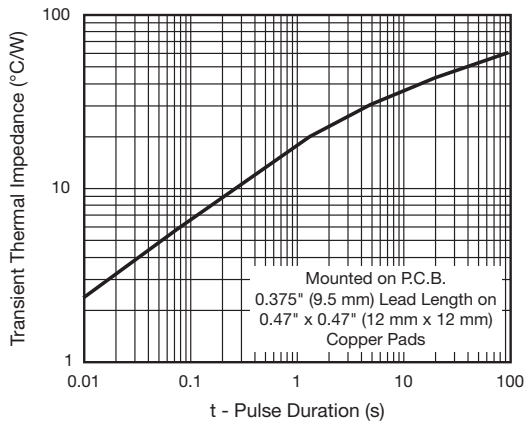
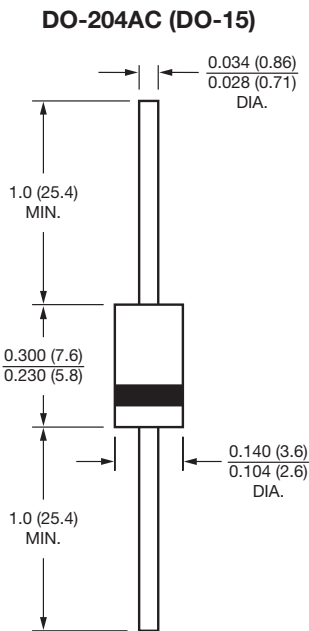


Fig. 7 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.